



LM158, LM258, LM358 LM158A, LM258A, LM358A

Low Power Dual Operational Amplifiers

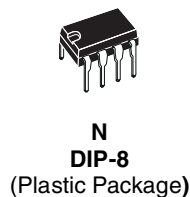
- Internally frequency compensated
- Large DC voltage gain: 100dB
- Wide bandwidth (unity gain): 1.1MHz (temperature compensated)
- Very low supply current/op (500 μ A) essentially independent of supply voltage
- Low input bias current: 20nA (temperature compensated)
- Low input offset voltage: 2mV
- Low input offset current: 2nA
- Input common-mode voltage range includes ground
- Differential input voltage range equal to the power supply voltage
- Large output voltage swing 0V to ($V_{CC} - 1.5V$)

Description

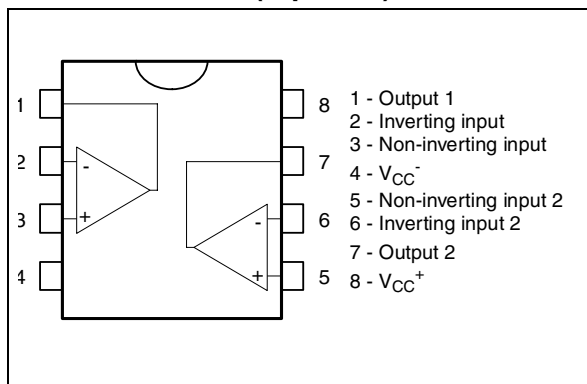
These circuits consist of two independent, high-gain, internally frequency-compensated which were designed specifically to operate from a single power supply over a wide range of voltages. The low power supply drain is independent of the magnitude of the power supply voltage.

Application areas include transducer amplifiers, DC gain blocks and all the conventional op-amp circuits which now can be more easily implemented in single power supply systems. For example, these circuits can be directly supplied with the standard +5V which is used in logic systems and will easily provide the required interface electronics without requiring any additional power supply.

In the linear mode the input common-mode voltage range includes ground and the output voltage can also swing to ground, even though operated from only a single power supply voltage..



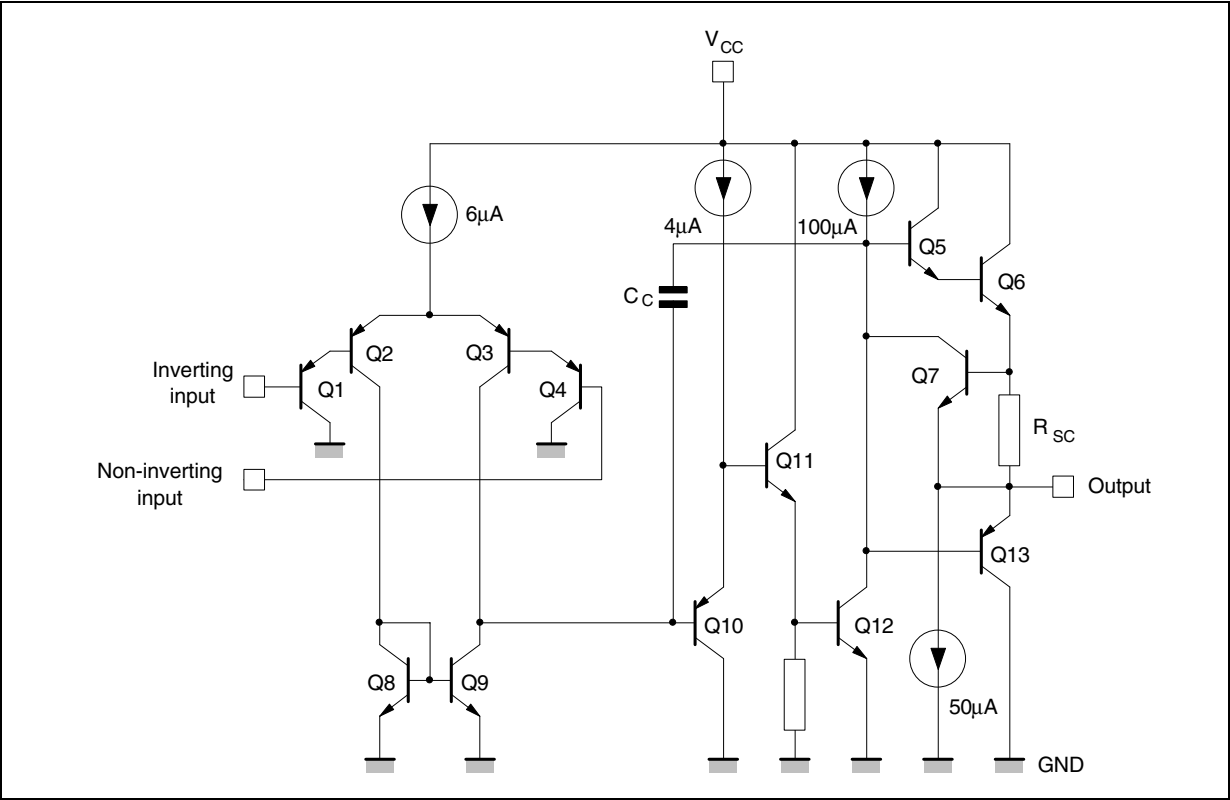
Pin Connections (top view)



Order Codes

Part Number	Temperature Range	Package	Packaging	Marking
LM158N	-55°C, +125°C	DIP-8	Tube	
LM158D		SO-8	Tube or Tape & Reel	
LM158DT				
LM158APT		TSSOP-8 (Thin Shrink Outline Package)	Tape & Reel	
LM258N	-40°C, +105°C	DIP-8	Tube	
LM258AN		SO-8	Tube or Tape & Reel	
LM258D				
LM258DT				
LM258AD				
LM258ADT		TSSOP-8 (Thin Shrink Outline Package)	Tape & Reel	
LM258PT	0°C, +70°C	DIP-8	Tube	
LM258APT		SO-8	Tube or Tape & Reel	
LM358N				
LM358AN				
LM358D				
LM358DT		TSSOP-8 (Thin Shrink Outline Package)	Tape & Reel	
LM358AD		mini SO-8	Tape & Reel	
LM358ADT				
LM358PT				
LM358APT				
LM358ST				
LM358AST				

Figure 1. Schematic diagram (1/2 LM158)



1 Absolute Maximum Ratings

Table 1. Key parameters and their absolute maximum ratings

Symbol	Parameter	LM158,A	LM258,A	LM358,A	Unit
V _{CC}	Supply voltage	+/-16 or 32			V
V _i	Input Voltage	-0.3 to +32			V
V _{id}	Differential Input Voltage	+32			V
P _{tot}	Power Dissipation ¹	500			mW
	Output Short-circuit Duration ²	Infinite			
I _{in}	Input Current ³	50			mA
T _{oper}	Operating Free-air Temperature Range	-55 to +125	-40 to +105	0 to +70	°C
T _{stg}	Storage Temperature Range	-65 to +150			°C
T _j	Maximum Junction Temperature	150			°C
R _{thja}	Thermal Resistance Junction to Ambient ⁴				°C/W
	SO8	125			
	TSSOP8	120			
	DIP8	85			
	miniSO8	190			

- 1) Power dissipation must be considered to ensure maximum junction temperature (T_j) is not exceeded.
- 2) Short-circuits from the output to V_{CC} can cause excessive heating if V_{CC} > 15V. The maximum output current is approximately 40mA independent of the magnitude of V_{CC}. Destructive dissipation can result from simultaneous short-circuit on all amplifiers.
- 3) This input current only exists when the voltage at any of the input leads is driven negative. It is due to the collector-base junction of the input PNP transistor becoming forward biased and thereby acting as input diodes clamps. In addition to this diode action, there is also NPN parasitic action on the IC chip. this transistor action can cause the output voltages of the Op-amps to go to the V_{CC} voltage level (or to ground for a large overdrive) for the time duration than an input is driven negative. This is not destructive and normal output will set up again for input voltage higher than -0.3V.
- 4) Short-circuits can cause excessive heating. Destructive dissipation can result from simultaneous short-circuit on all amplifiers

2 Electrical Characteristics

Table 2. Electrical characteristics for $V_{CC}^+ = +5V$, $V_{CC}^- = \text{Ground}$, $V_O = 1.4V$, $T_{amb} = +25^\circ C$ (unless otherwise specified)

Symbol	Parameter	LM158A-LM258A LM358A			LM158-LM258 LM358			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	
V_{io}	Input Offset Voltage - note ¹ $T_{amb} = +25^\circ C$ LM158, LM258 LM158A $T_{min} \leq T_{amb} \leq T_{max}$ LM158, LM258		1	3 2 4		2	7 5 9 7	mV
I_{io}	Input Offset Current $T_{amb} = +25^\circ C$ $T_{min} \leq T_{amb} \leq T_{max}$		2	10 30		2	30 40	nA
I_{ib}	Input Bias Current - note ² $T_{amb} = +25^\circ C$ $T_{min} \leq T_{amb} \leq T_{max}$		20	50 100		20	150 200	nA
A_{vd}	Large Signal Voltage Gain $V_{CC} = +15V$, $R_L = 2k\Omega$, $V_O = 1.4V$ to $11.4V$ $T_{amb} = +25^\circ C$ $T_{min} \leq T_{amb} \leq T_{max}$	50 25	100		50 25	100		V/mV
SVR	Supply Voltage Rejection Ratio ($R_s \leq 10k\Omega$) $V_{CC}^+ = 5V$ to $30V$ $T_{amb} = +25^\circ C$ $T_{min} \leq T_{amb} \leq T_{max}$	65 65	100		65 65	100		dB
I_{CC}	Supply Current, all Amp, no load $T_{min} \leq T_{amb} \leq T_{max}$ $V_{CC} = +5V$ $T_{min} \leq T_{amb} \leq T_{max}$ $V_{CC} = +30V$		0.7	1.2 2		0.7	1.2 2	mA
V_{icm}	Input Common Mode Voltage Range $V_{CC} = +30V$ - note ³ $T_{amb} = +25^\circ C$ $T_{min} \leq T_{amb} \leq T_{max}$	0 0		$V_{CC}^+ - 1.5$ $V_{CC}^+ - 2$	0 0		$V_{CC}^+ - 1.5$ $V_{CC}^+ - 2$	V
CMR	Common Mode Rejection Ratio ($R_s \leq 10k\Omega$) $T_{amb} = +25^\circ C$ $T_{min} \leq T_{amb} \leq T_{max}$	70 60	85		70 60	85		dB
I_{source}	Output Current Source $V_{CC} = +15V$, $V_O = +2V$, $V_{id} = +1V$	20	40	60	20	40	60	mA
I_{sink}	Output Sink Current ($V_{id} = -1V$) $V_{CC} = +15V$, $V_O = +2V$ $V_{CC} = +15V$, $V_O = +0.2V$	10 12	20 50		10 12	20 50		mA μA
V_{OPP}	Output Voltage Swing ($R_L = 2k\Omega$) $T_{amb} = +25^\circ C$ $T_{min} \leq T_{amb} \leq T_{max}$	0 0		$V_{CC}^+ - 1.5$ $V_{CC}^+ - 2$	0 0		$V_{CC}^+ - 1.5$ $V_{CC}^+ - 2$	

Table 2. Electrical characteristics for $V_{CC}^+ = +5V$, $V_{CC}^- = \text{Ground}$, $V_O = 1.4V$, $T_{amb} = +25^\circ C$ (unless otherwise specified)

Symbol	Parameter	LM158A-LM258A LM358A			LM158-LM258 LM358			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	
V_{OH}	High Level Output Voltage ($V_{CC}^+ = 30V$) $T_{amb} = +25^\circ C$ $R_L = 2k\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$ $T_{amb} = +25^\circ C$ $R_L = 10k\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$	26 26 27 27	27 28		26 26 27 27	27 28		V
V_{OL}	Low Level Output Voltage ($R_L = 10k\Omega$) $T_{amb} = +25^\circ C$ $T_{min} \leq T_{amb} \leq T_{max}$		5	20 20		5	20 20	mV
SR	Slew Rate $V_{CC} = 15V$, $V_i = 0.5$ to $3V$, $R_L = 2k\Omega$, $C_L = 100pF$, unity Gain	0.3	0.6		0.3	0.6		V/ μs
GBP	Gain Bandwidth Product $V_{CC} = 30V$, $f = 100kHz$, $V_{in} = 10mV$, $R_L = 2k\Omega$, $C_L = 100pF$	0.7	1.1		0.7	1.1		MHz
THD	Total Harmonic Distortion $f = 1kHz$, $A_v = 20dB$, $R_L = 2k\Omega$, $V_O = 2V_{pp}$, $C_L = 100pF$, $V_O = 2V_{pp}$		0.02			0.02		%
e_n	Equivalent Input Noise Voltage $f = 1kHz$, $R_s = 100\Omega$, $V_{CC} = 30V$		55			55		$\frac{nV}{\sqrt{Hz}}$
DV_{io}	Input Offset Voltage Drift		7	15		7	30	$\mu V/^\circ C$
DI_{lio}	Input Offset Current Drift		10	200		10	300	$pA/^\circ C$
V_{o1}/V_{o2}	Channel Separation - note ⁴ $1kHz \leq f \leq 20kHz$		120			120		dB

1) $V_O = 1.4V$, $R_s = 0\Omega$, $5V < V_{CC}^+ < 30V$, $0 < V_{ic} < V_{CC}^+ - 1.5V$

2) The direction of the input current is out of the IC. This current is essentially constant, independent of the state of the output so no loading change exists on the input lines.

3) The input common-mode voltage of either input signal voltage should not be allowed to go negative by more than 0.3V. The upper end of the common-mode voltage range is $V_{CC}^+ - 1.5V$, but either or both inputs can go to +32V without damage.

4) Due to the proximity of external components insure that coupling is not originating via stray capacitance between these external parts. This typically can be detected as this type of capacitance increases at higher frequencies.

Figure 2. Open loop frequency response

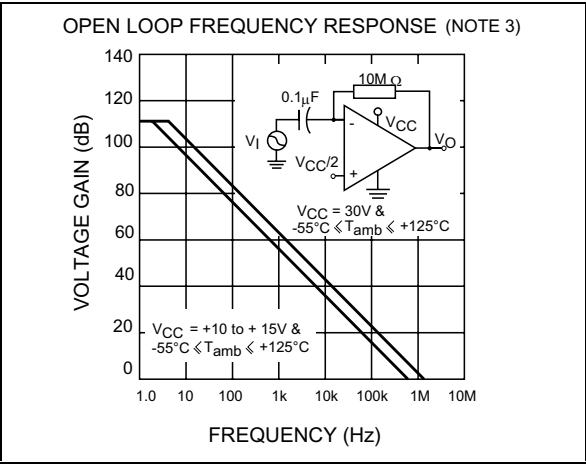


Figure 3. Large signal frequency response

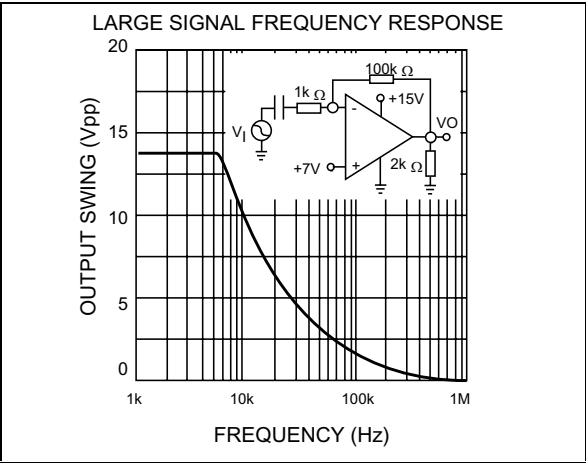


Figure 4. Voltage follower pulse response

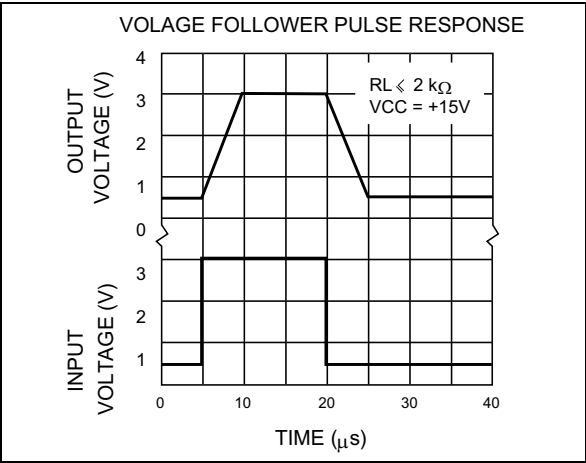


Figure 5. Voltage follower pulse response

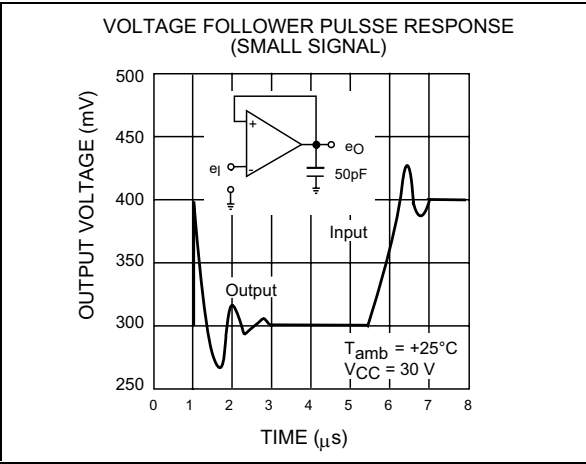


Figure 6. Input current

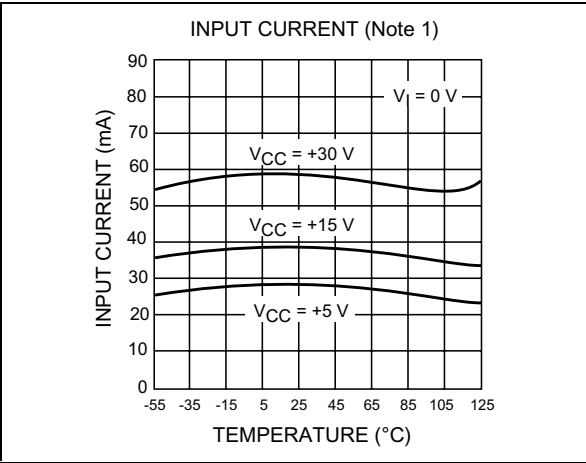


Figure 7. Output characteristics

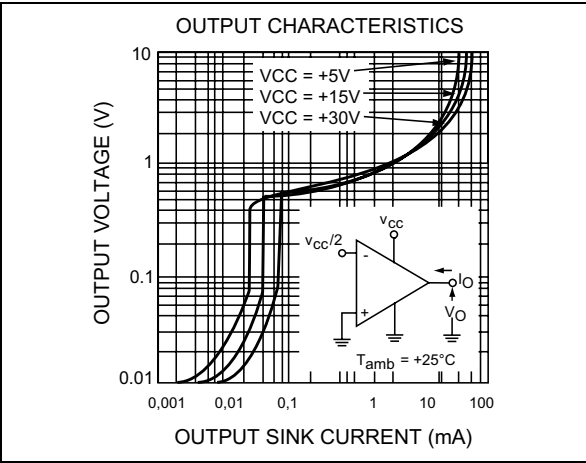


Figure 8. Output characteristics

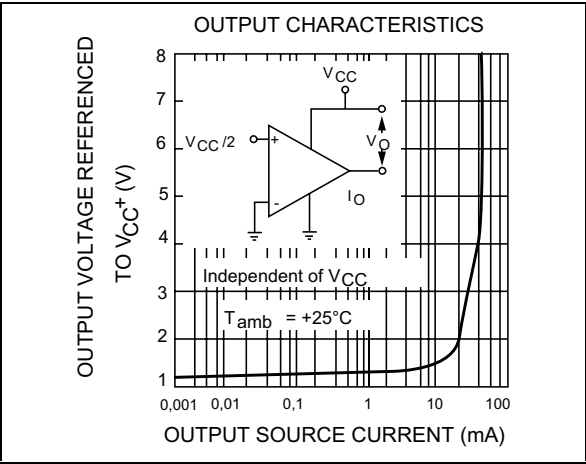


Figure 9. Current limiting

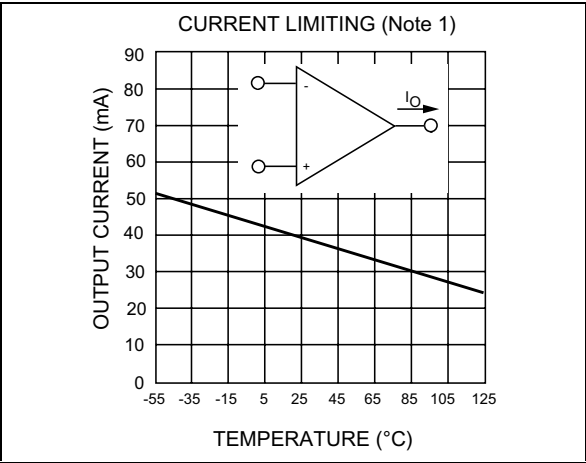


Figure 10. Input voltage range

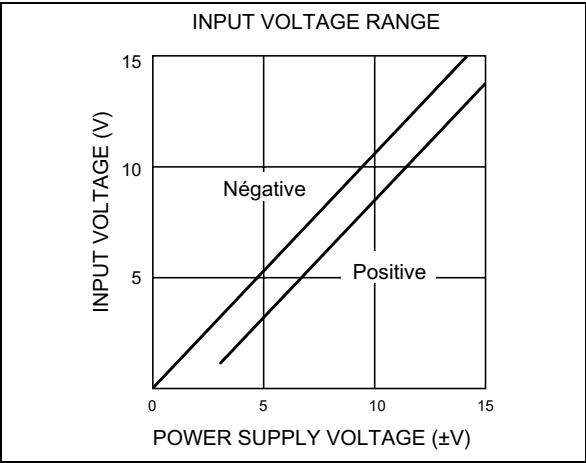


Figure 11. Positive supply voltage

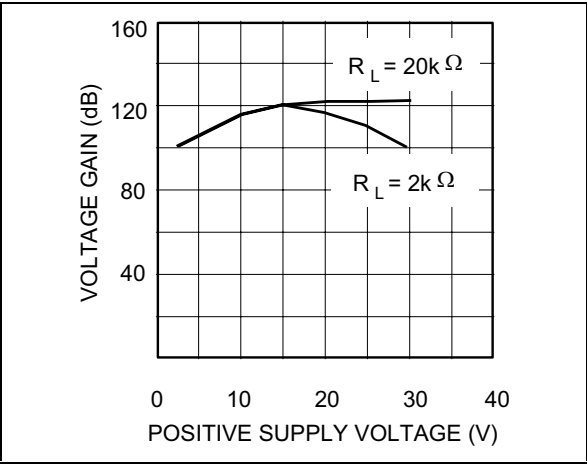


Figure 12. Positive supply voltage

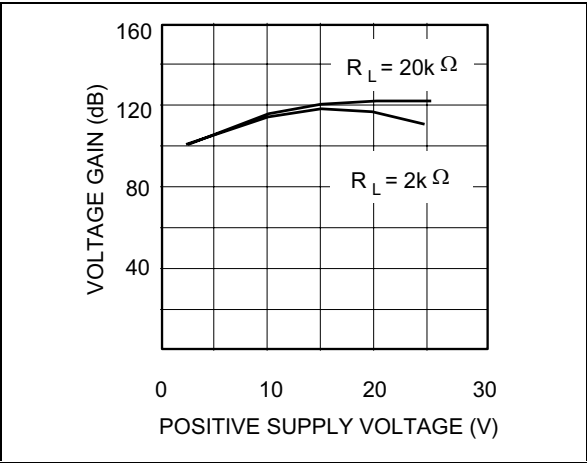


Figure 13. Supply current

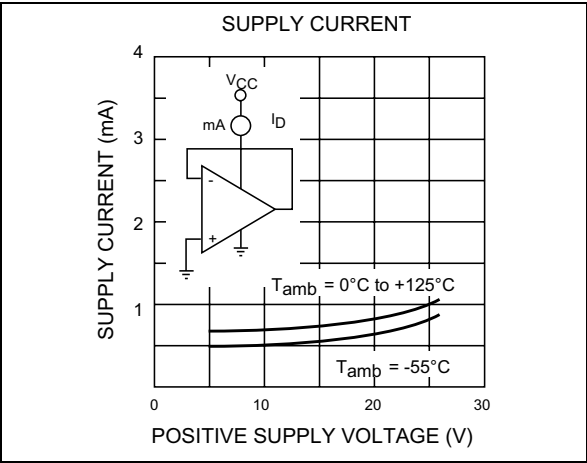


Figure 14. Input current

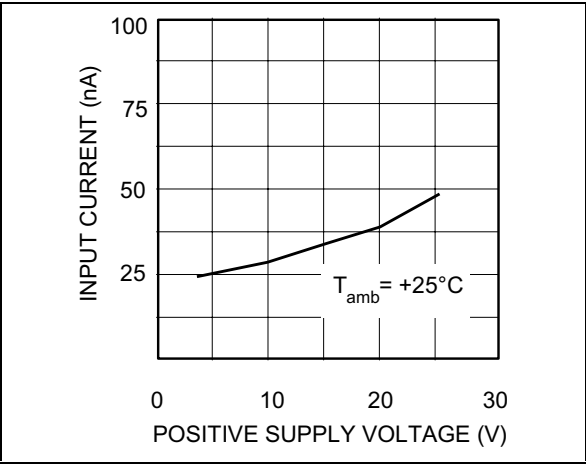


Figure 17. Common mode rejection ratio

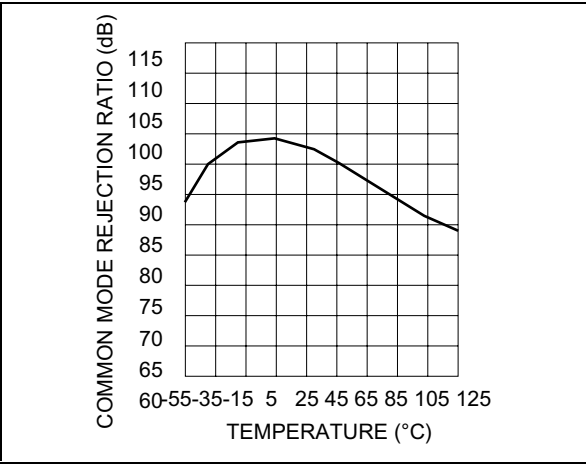


Figure 15. Gain bandwidth product

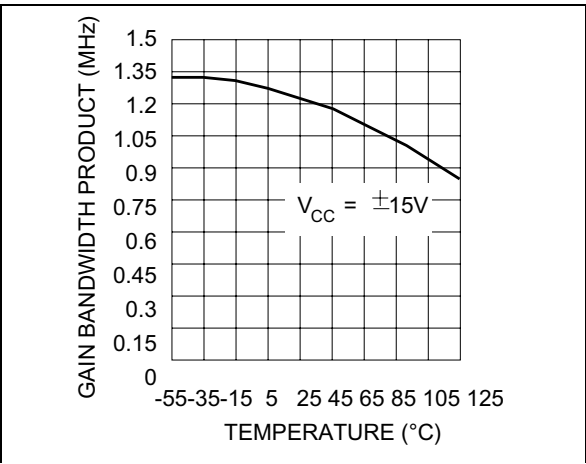
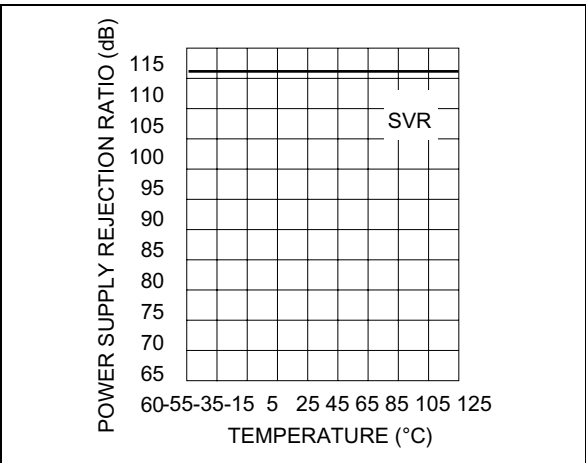


Figure 16. Power supply rejection ratio



3 Typical Applications

(single supply voltage) $V_{CC} = +5V_{DC}$

Figure 18. AC coupled inverting amplifier

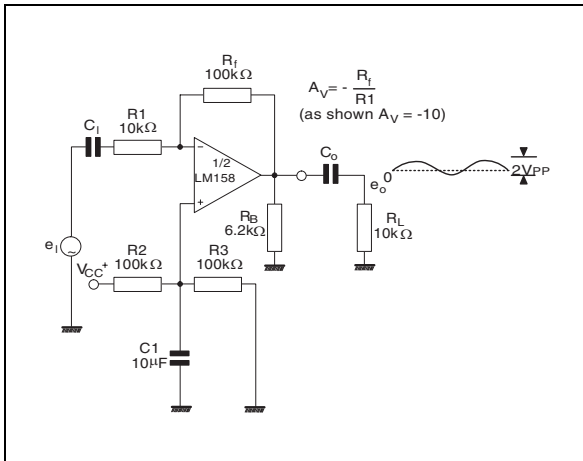


Figure 19. Non-inverting DC amplifier

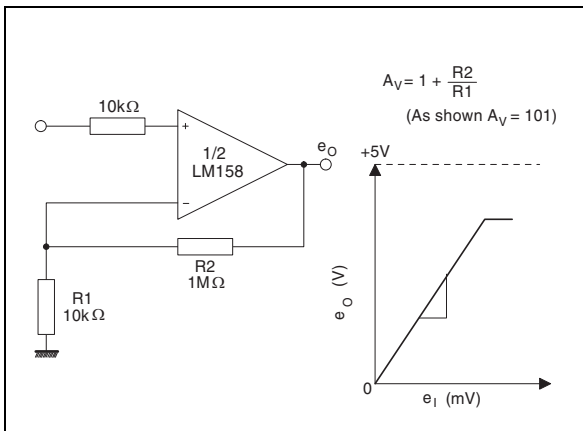


Figure 20. AC Coupled Non-inverting Amplifier

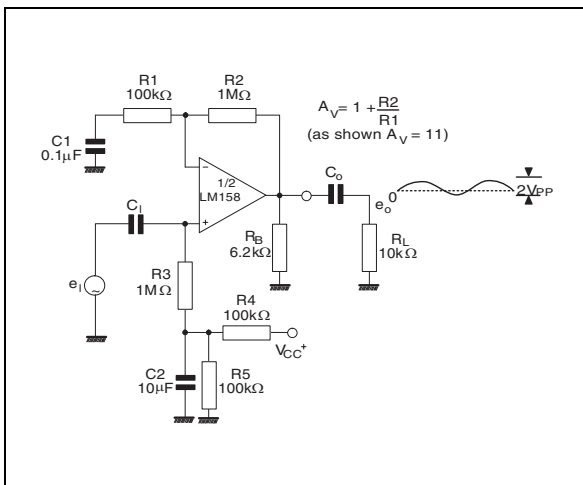


Figure 21. DC summing amplifier

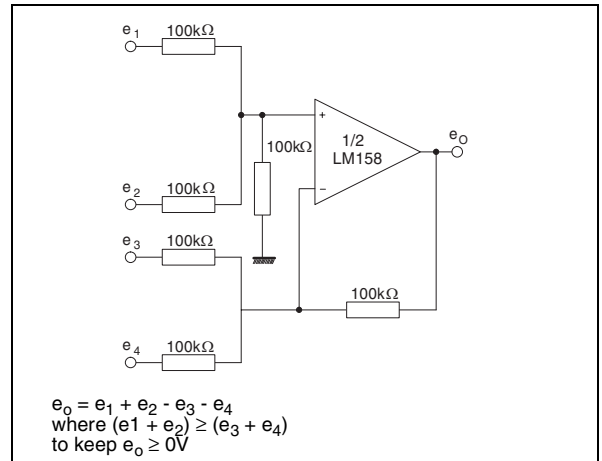


Figure 22. High input Z, DC differential amplifier

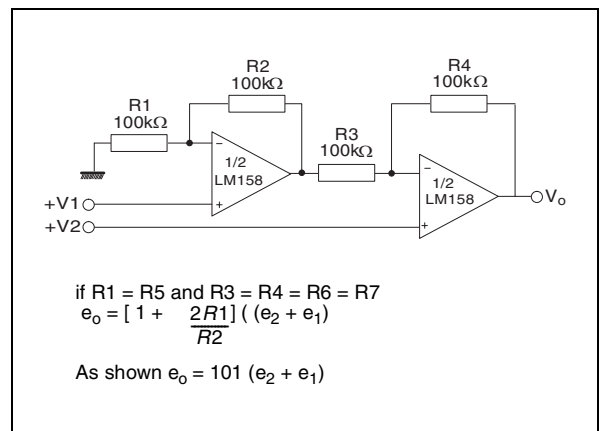
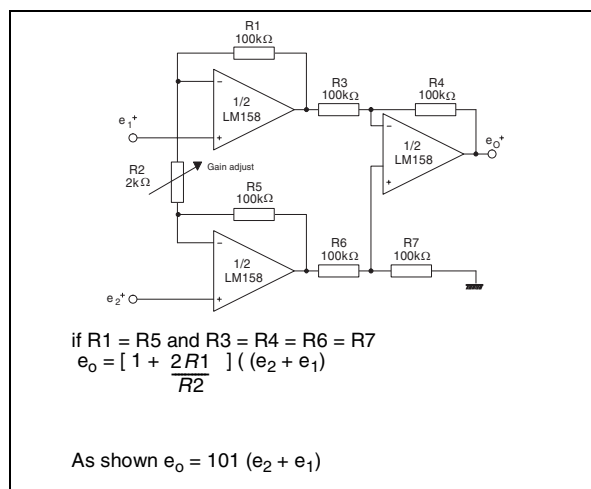
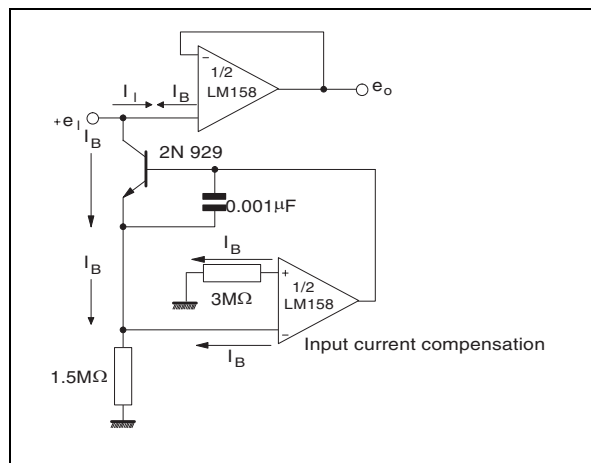
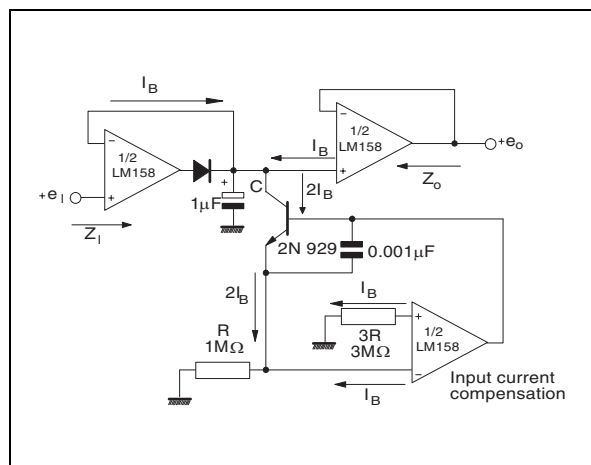
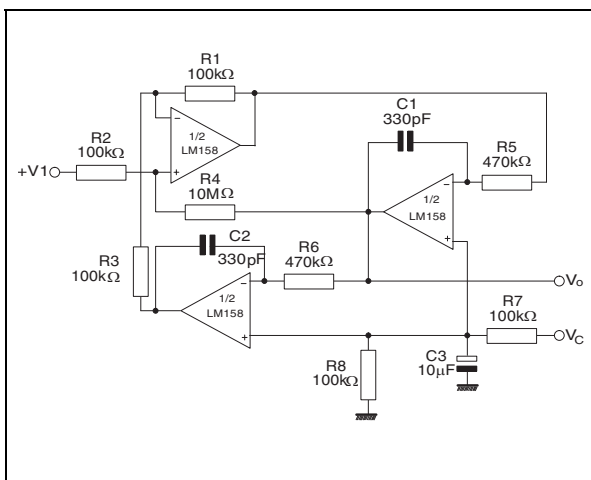


Figure 23. High input Z adjustable gain DC instrumentation amplifier**Figure 24. Using symmetrical amplifiers to reduce input current****Figure 25. Low drift peak detector****Figure 26. Active band-pass filter**

4 Package Mechanical Data

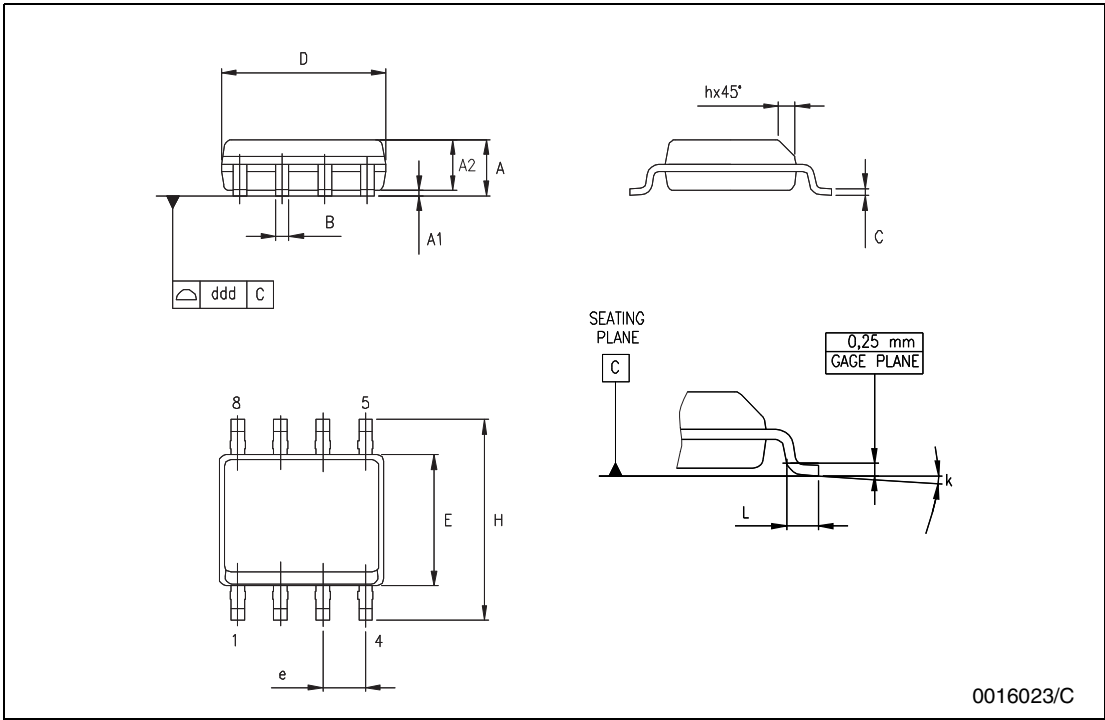
Plastic DIP-8 MECHANICAL DATA						
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A		3.3			0.130	
a1	0.7			0.028		
B	1.39		1.65	0.055		0.065
B1	0.91		1.04	0.036		0.041
b		0.5			0.020	
b1	0.38		0.5	0.015		0.020
D			9.8			0.386
E		8.8			0.346	
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			7.1			0.280
I			4.8			0.189
L		3.3			0.130	
Z	0.44		1.6	0.017		0.063

The image contains three mechanical drawings of a Plastic DIP-8 package. The top-left drawing is a side view showing dimensions A (package height), a1 (lead height), B (lead spacing), B1 (lead width), b (lead thickness), b1 (lead tip thickness), e (lead pitch), e3 (total lead width), e4 (package width), E (body width), and Z (lead standoff). The top-right drawing is another side view showing e4, b1, and E. The bottom drawing is a top-down view showing the pin layout with pins numbered 1, 4, 5, and 8, and dimensions D (package length) and L (package thickness).

P001F

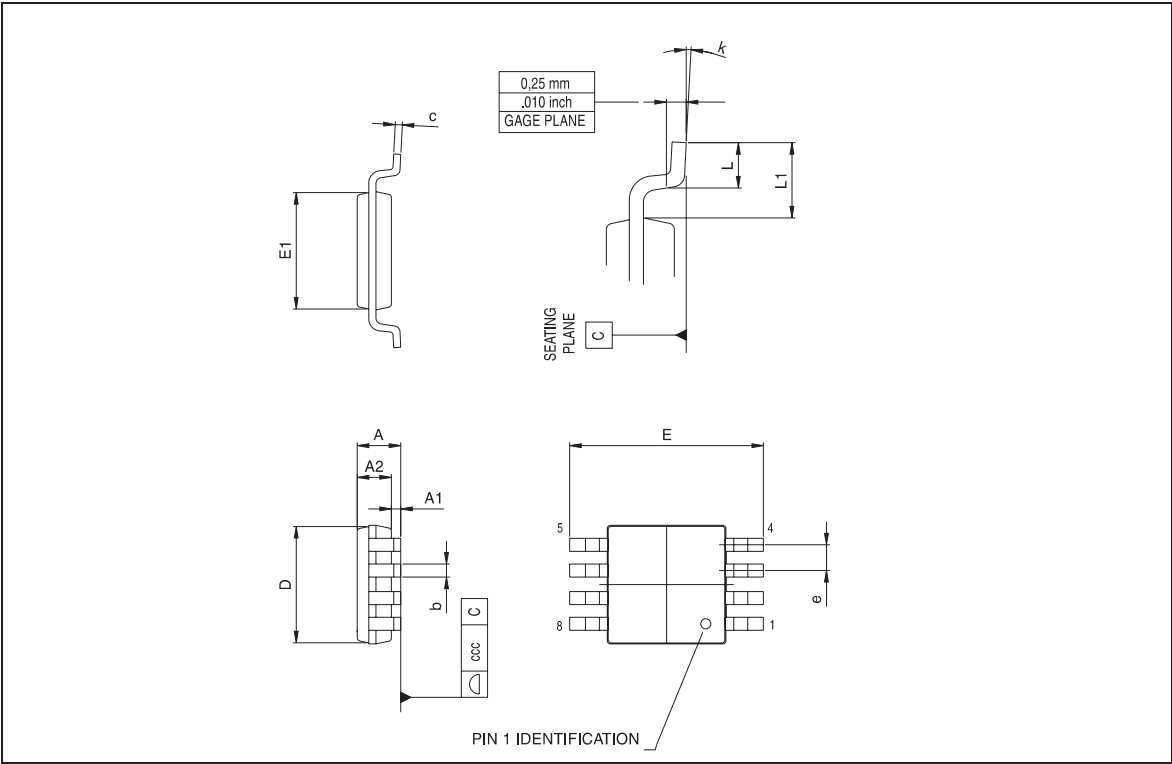
SO-8 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.04		0.010
A2	1.10		1.65	0.043		0.065
B	0.33		0.51	0.013		0.020
C	0.19		0.25	0.007		0.010
D	4.80		5.00	0.189		0.197
E	3.80		4.00	0.150		0.157
e		1.27			0.050	
H	5.80		6.20	0.228		0.244
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	8° (max.)					
ddd			0.1			0.04



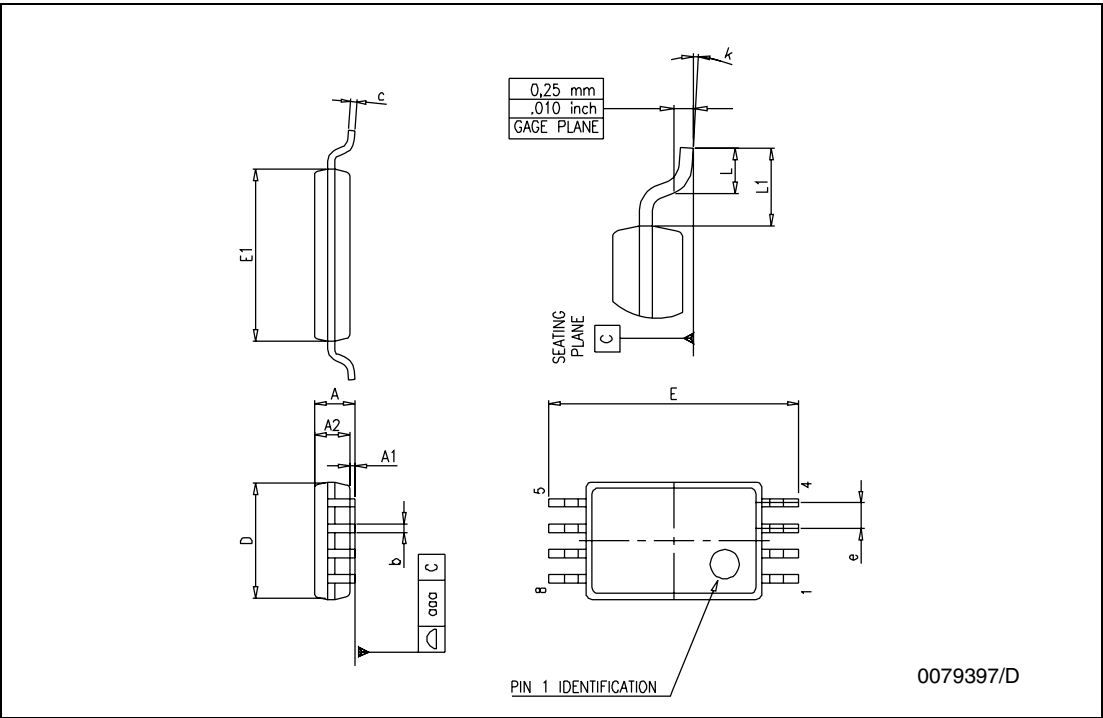
miniISO-8 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.1			0.043
A1	0.05	0.10	0.15	0.002	0.004	0.006
A2	0.78	0.86	0.94	0.031	0.031	0.037
b	0.25	0.33	0.40	0.010	0.13	0.013
c	0.13	0.18	0.23	0.005	0.007	0.009
D	2.90	3.00	3.10	0.114	0.118	0.122
E	4.75	4.90	5.05	0.187	0.193	0.199
E1	2.90	3.00	3.10	.0114	0.118	0.122
e		0.65			0.026	
K	0°		6°	0°		6°
L	0.40	0.55	0.70	0.016	0.022	0.028
L1			0.10			0.004



TSSOP8 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002		0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.008
D	2.90	3.00	3.10	0.114	0.118	0.122
E	6.20	6.40	6.60	0.244	0.252	0.260
E1	4.30	4.40	4.50	0.169	0.173	0.177
e		0.65			0.0256	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030
L1		1			0.039	



5 Summary of Changes

Date	Revision	Description of Changes
01 July 2003	1	First Release
01 Jan. 2005	2	Rthja and Tj parameters added in AMR Table 1 on page 3

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